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Revision History

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http://www.ti.com

Change in menu Project|Project Options|Parameters

Project Title:

Designed for:

Public Release

Assembly Variant:

001

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Drawn By:

Engineer:

Enter name of project lead

Orderable:

N/A

Revision History

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These assemblies are ESD sensitive, ESD precautions shall be observed.

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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